

October 1987 Revised June 2001

# MM88C29 • MM88C30 Quad Single-Ended Line Driver • Dual Differential Line Driver

# **General Description**

The MM88C30 is a dual differential line driver that also performs the dual four-input NAND or dual four-input AND function. The absence of a clamp diode to  $V_{CC}$  in the input protection circuitry of the MM88C30 allows a CMOS user to interface systems operating at different voltage levels. Thus, a CMOS digital signal source can operate at a  $V_{CC}$  voltage greater than the  $V_{CC}$  voltage of the MM88C30 line driver. The differential output of the MM88C30 eliminates ground-loop errors.

The MM88C29 is a non-inverting single-wire transmission line driver. Since the output ON resistance is a low  $20\Omega$  typ., the device can be used to drive lamps, relays, solenoids, and clock lines, besides driving data lines.

#### **Features**

■ Wide supply voltage range: 3V to 15V
■ High noise immunity: 0.45 V<sub>CC</sub> (typ.)

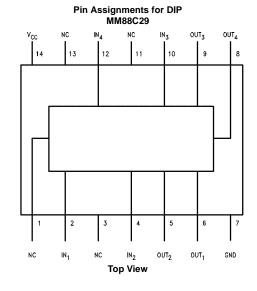
■ Low output ON resistance:  $20\Omega$  (typ.)

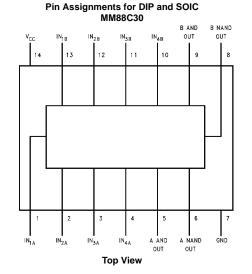
### **Ordering Code:**

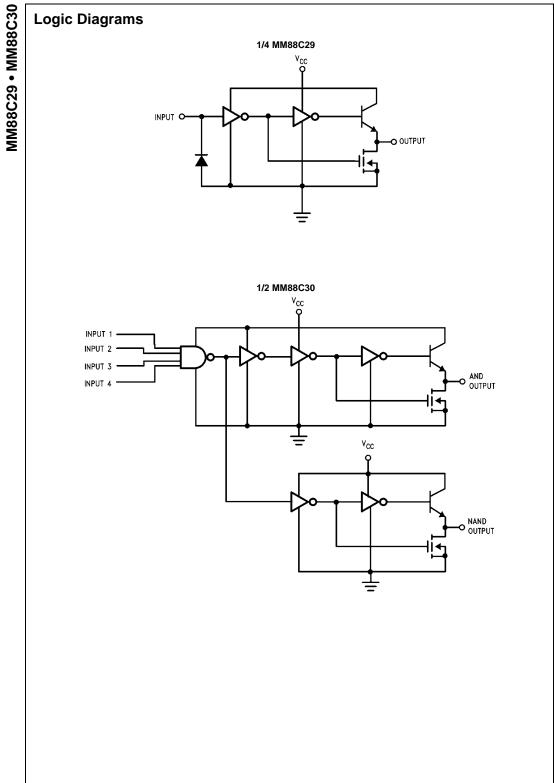
Order Number	Package Number	Package Description
MM88C29N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
MM88C30M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
MM88C30N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Devices also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code

#### **Connection Diagrams**







# **Absolute Maximum Ratings**(Note 1)

 $\begin{array}{lll} \mbox{Voltage at Any Pin (Note 2)} & -0.3 \mbox{V to V}_{\mbox{CC}} + 16 \mbox{V} \\ \mbox{Operating Temperature Range} & -40 \mbox{°C to } + 85 \mbox{°C} \\ \mbox{Storage Temperature} & -65 \mbox{°C to } + 150 \mbox{°C} \\ \end{array}$ 

Power Dissipation (P<sub>D</sub>)

 $\begin{array}{ccc} \text{Dual-In-Line} & 700 \text{ mW} \\ \text{Small Outline} & 500 \text{ mW} \\ \text{Operating V}_{\text{CC}} \text{ Range} & 3V \text{ to 15V} \\ \text{Absolute Maximum V}_{\text{CC}} & 18V \\ \end{array}$ 

Average Current at Output MM88C30

 $\begin{array}{c} \text{MM88C30} & \text{50 mA} \\ \text{MM88C29} & \text{25 mA} \\ \text{Maximum Junction Temperature, T}_{i} & \text{150°C} \\ \end{array}$ 

Lead Temperature

(Soldering, 10 seconds) 260°C

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The Electrical Characteristics tables provide conditions for actual device operation.

Note 2: AC Parameters are guaranteed by DC correlated testing.

#### **DC Electrical Characteristics**

Min/Max limits apply across temperature range unless otherwise noted

Symbol	Parameter	Conditions	Min	Тур	Max	Units
CMOS TO	CMOS		•	•		
V <sub>IN(1)</sub>	Logical "1" Input Voltage	$V_{CC} = 5V$	3.5			V
		V <sub>CC</sub> = 10V	8			V
V <sub>IN(0)</sub>	Logical "0" Input Voltage	V <sub>CC</sub> = 5V			1.5	V
		V <sub>CC</sub> = 10V			2	V
IN(1)	Logical "1" Input Current	V <sub>CC</sub> = 15V, V <sub>IN</sub> = 15V		0.005	1	μΑ
IN(0)	Logical "0" Input Current	$V_{CC} = 15V, V_{IN} = 0V$	-1	-0.005		μΑ
СС	Supply Current	V <sub>CC</sub> = 5V		0.05	100	mA
DUTPUT I	DRIVE	-		ı	ı	ı
I <sub>SOURCE</sub>	Output Source Current	$V_{OUT} = V_{CC} - 1.6V,$				
		$V_{CC} \ge 4.75V, T_i = 25^{\circ}C$	-47	-80		mA
		T <sub>i</sub> = 85°C	-32	-60		mA
	MM88C29	$V_{OUT} = V_{CC} - 0.8V$	-2	-20		mA
	MM88C30	V <sub>CC</sub> ≥ 4.5V				
I <sub>SINK</sub>	Output Sink Current	V <sub>OUT</sub> = 0.4V, V <sub>CC</sub> = 4.75V,				
		$T_i = 25$ °C	9.5	22		mA
		T <sub>i</sub> = 85°C	8	18		mA
		$V_{OUT} = 0.4V, V_{CC} = 10V,$				
		$T_i = 25$ °C	19	40		mA
		T <sub>i</sub> = 125°C	15.5	33		mA
SOURCE	Output Source Resistance	$V_{OUT} = V_{CC} - 1.6V,$				
		V <sub>CC</sub> ≥ 4.75V, T <sub>i</sub> = 25°C		20	34	Ω
		T <sub>i</sub> = 85°C		27	50	Ω
SINK	Output Sink Resistance	$V_{OUT} = 0.4V, V_{CC} = 4.75V,$				
Cita		T <sub>i</sub> = 25°C		18	41	Ω
		T <sub>i</sub> = 85°C		22	50	Ω
		$V_{OUT} = 0.4V, V_{CC} = 10V,$				
		T <sub>i</sub> = 25°C		10	21	Ω
		T <sub>i</sub> = 85°C		12	26	Ω
	Output Resistance	,				
	Temperature Coefficient					
	Source			0.55		%/°C
	Sink			0.40		%/°C
ЭЈА	Thermal Resistance			150		°C/W
~JA	(N-Package)					]

# AC Electrical Characteristics (Note 2)

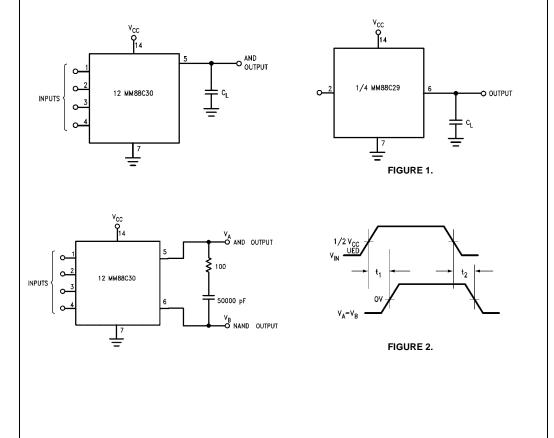
 $T_A = 25^{\circ}C, C_L = 50 \text{ pF}$ 

Symbol	Parameter	Conditions	Min	Тур	Max	Units
t <sub>pd</sub>	Propagation Delay Time to					
	Logical "1" or "0"	(See Figure 1)				
	MM88C29	$V_{CC} = 5V$		80	200	ns
		V <sub>CC</sub> = 10V		35	100	ns
	MM88C30	V <sub>CC</sub> = 5V		110	350	ns
		V <sub>CC</sub> = 10V		50	150	ns
t <sub>pd</sub>	Differential Propagation Delay	$R_L = 100\Omega, C_L = 5000 \text{ pF}$				
	Time to Logical "1" or "0"	(See Figure 2)				
	MM88C30	V <sub>CC</sub> = 5V			400	ns
		V <sub>CC</sub> = 10V			150	ns
C <sub>IN</sub>	Input Capacitance					
	MM88C29	(Note 3)		5.0		pF
	MM88C30	(Note 3)		5.0		pF
C <sub>PD</sub>	Power Dissipation Capacitance					
	MM88C29	(Note 3)		150		pF
	MM88C30	(Note 3)		200		pF

Note 3: Capacitance is guaranteed by periodic testing.

Note 4: C<sub>PD</sub> determines the no load AC power consumption of any CMOS device. For complete explanation see Family Characteristics application note AN-90 (CMOS Logic Databook).

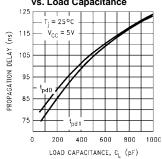
## **AC Test Circuits**



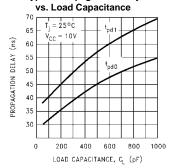
# **Typical Applications Digital Data Transmission** C1 0.01 μF (NOTE A) LINE DRIVER AND RECEIVER (NOTE C) AND OUTPUT TWISTED PAIR LINE 1/2 MM88C30 1/2 DS78C20 O OUTPUT INPUT NAND OUTPUT C2 100 pF (NOTE B) STROBE Note A: Exact value depends on line length. Note B: Optional to control response time. Note C: $V_{CC}$ = 4.5V to 5.5V for the DS7820, $V_{CC}$ =4.5V to 15V for the DS78C20. AND OUTPUT TWISTED PAIR LINE 20k NAND OUTPUT <u>\_</u>7 SINGLE-WAVE TRANSMISSION LINE (NOTE 1) OUTPUT 1/6 MM88C30 INPUT O 1/6 MM74C914 OR 1/6 MM74C14 V<sub>CC</sub> is 3V to 15V. Typical Data Rate vs Transmission Line Length Note: The transmission line used was #22 gauge unshielded twisted pair 10<sup>4</sup> T<sub>A</sub> = 25°C Note: The curves generated assume that both drivers are driving equal lines, and that the maximum power is 500 mW/package. TYPICAL DATA RATE (kHz) 10<sup>3</sup> 10<sup>2</sup> 10<sup>1</sup> 10<sup>0</sup> 10<sup>1</sup> LENGTH OF TRANSMISSION LINE (FT)

# **Typical Performance Characteristics**

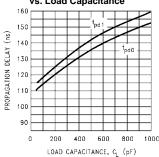
# MM88C29 Typical Propagation Delay vs. Load Capacitance



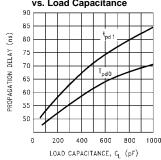
# MM88C29 Typical Propagation Delay



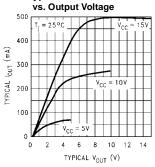
#### MM88C30 Typical Propagation Delay vs. Load Capacitance



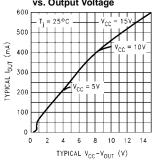
#### MM88C30 Typical Propagation Delay vs. Load Capacitance

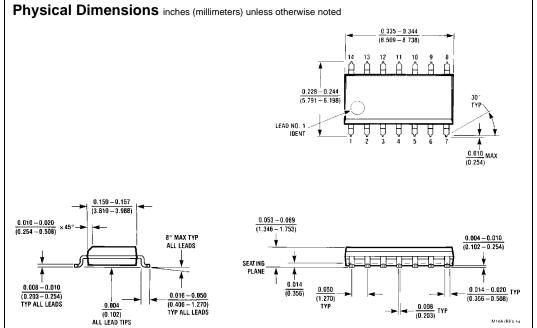


# Typical Sink Current



# Typical Source Current vs. Output Voltage





14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Package Number M14A

#### Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 0.740 - 0.770 (18.80 - 19.56)0.090 (2.286) 14 13 12 11 10 9 8 14 13 12 INDEX AREA 0.250 ± 0.010 (6.350 ± 0.254) PIN NO. 1 PIN NO. 1 IDENT 1 2 3 4 5 6 7 1 2 3 $\frac{0.092}{(2.337)}$ DIA 0.030 MAX (0.762) DEPTH OPTION 1 OPTION 02 $\frac{0.135 \pm 0.005}{(3.429 \pm 0.127)}$ 0.300 - 0.320 $\frac{0.630 - 8.128}{(7.620 - 8.128)}$ 0.060 0.145 - 0.2004° TYP Optional (1.651) (3.683 - 5.080) $\frac{0.008 - 0.016}{(0.203 - 0.406)}$ TYP 0.020 (0.508) 0.125 - 0.150 $0.075 \pm 0.015$ $\overline{(3.175 - 3.810)}$ $(1.905 \pm 0.381)$ (7.112) MIN 0.014 - 0.0230.100 ± 0.010 (2.540 ± 0.254) (0.356 - 0.584) $\frac{0.050 \pm 0.010}{(1.270 - 0.254)}$ TYP 0.325 <sup>+0.040</sup> -0.015 8.255 + 1.016

14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N14A

Fairchild does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and Fairchild reserves the right at any time without notice to change said circuitry and specifications.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com

N14A (REV F)